



Board Characteristics - 16 LAYER BOARD

- Material: Nelco N4000-13EPSI
- Minimum trace width: 0.006" and clearance: 0.005" on Signal 1,6 (Top and Bottom);
- Minimum trace width and clearance: 0.005" on Signal 2,3,4,5,7,8,9,10,11,12 (all stripline);
- 1 oz copper for all power layers and for Signal 1,2 (Top and Bottom)
1/2 oz copper for Stripline trace layers (Signal 2,3,4,5,7,10,11,12).
- Electroless Nickel Immersion Gold plating, with min. Ni: 2.5-5 um; Au: 0.05-0.2 um.
Apply Solder Mask over bare copper.
- Board Thickness: 0.093 +/- 0.008
- Mill the Top and Bottom of board on the solder side to a thickness of 0.063" +/- 0.008
- Silkscreen on Component and Solder Sides.
- 45 degree chamfer.
- FHS tolerances: +/- 0.003 unless specified otherwise.
- Interlayer spacing as specified.
- Zc=55 Ohm, Zd=100 Ohm for all 0.005" stripline and all 0.006" microstrip traces.
Perform TDR test for all signal layers.
Present TDR test results for all signal layers.
- Via Fill and Overplate:
Vias of this diameter must be completely filled with Peters PP-2795 or equivalent, planarized, and plated over with Copper and surface finish.
The plated cap must adhere to fill material after 1x 550F solder shock.
- Remove all non-functional inner layer pads for pins and vias.
- Do not increase size of thermal pads and associated spoke connections on 0.041" and 0.0413" holes.

BOARD'S DRILL SCHEDULE

DRILL SYMBOL	DRILL SIZE	COUNT	PLATED	Tolerance	COMMENT
○	.009	1124	YES	---	
⊞	.0091	1651	YES	---	Note 13
⊕	.011811024	22	YES	---	
⊞	.02	2	YES	---	
⊖	.033464567	2	YES	---	
⊞	.035	40	YES	---	
⊕	.037401575	18	YES	---	
□	.041	562	YES	---	
	.041338583	20	YES	---	
	.042	20	YES	---	
	.057	2	YES	---	
	.059	6	YES	---	
	.061023622	4	YES	---	
	.066	22	YES	---	
	.067	24	YES	---	
	.07	4	YES	---	
	.091	13	YES	---	
	.106	6	NO	---	
	.12598425	2	NO	---	
	.12795276	7	YES	---	
	.15	4	NO	---	

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES .XX .XXX DO NOT SCALE DRAWING		CONTRACT NO.		UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP		
TREATMENT		APPROVALS	DATE	TITLE		
FINISH		DRAWN M. Bogdan	9/30/2015	Annie's Central Card Specification Drawing		
SIMILAR TO		CHECKED M. Bogdan	9/30/2015	SIZE B	FSCM NO.	DWG. NO. 2857
ACT. WT	CALC WT	ISSUED		SCALE 1/2		REV. A
						SHEET